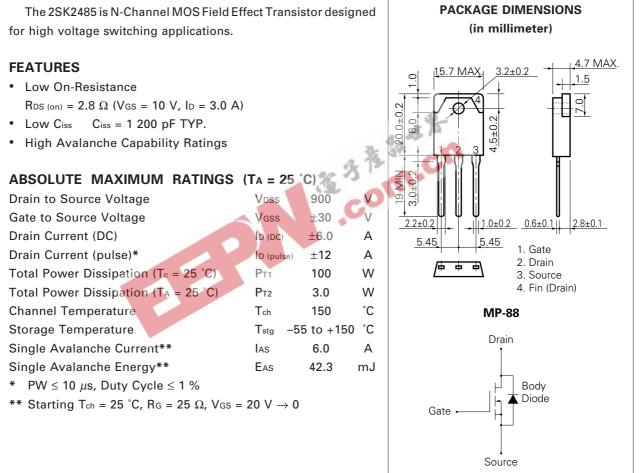
DATA SHEET

NEC

MOS FIELD EFFECT TRANSISTOR **2SK2485**

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

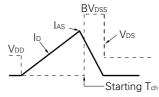


ELECTRICAL	CHARACTERISTICS	(TA = 25 °C)
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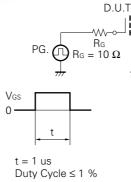
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-Resistance	RDS (on)		2.2	2.8	Ω	$V_{GS} = 10 \text{ V}, \text{ Id} = 3.0 \text{ A}$
Gate to Source Cutoff Voltage	VGS (off)	2.5		3.5	V	$V_{DS} = 10 V, I_{D} = 1 mA$
Forward Transfer Admittance	y _{fs}	2.0			S	Vds = 10 V, Id = 3.0 A
Drain Leakage Current	loss			100	μA	$V_{DS} = V_{DSS}, V_{GS} = 0$
Gate to Source Leakage Current	lgss			±100	nA	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0$
Input Capacitance	Ciss		1200		pF	V _{DS} = 10 V
Output Capacitance	Coss		170		pF	Vgs = 0
Reverse Transfer Capacitance	Crss		30		pF	f = 1 MHz
Turn-On Delay Time	td (on)		20		ns	ID = 3.0 A
Rise Time	tr		10		ns	$V_{GS} = 10 V$
Turn-Off Delay Time	td (off)		70		ns	V _{DD} = 150 V
Fall Time	tr		15		ns	$R_G = 10 \ \Omega R_L = 50 \ \Omega$
Total Gate Charge	QG		40		nC	ID = 6.0 A
Gate to Source Charge	Q _{GS}		7		nC	$V_{DD} = 450 V$
Gate to Drain Charge	Qgd		17	23	nC	Vgs = 10 V
Body Diode Forward Voltage	VF (S-D)		1.0	3	V	IF = 6.0 A, VGS = 0
Reverse Recovery Time	trr		740	05	ns	IF = 6.0 A, VGS = 0
Reverse Recovery Charge	Qrr	S	4.0	-	μC	di/dt = 50 A/µs

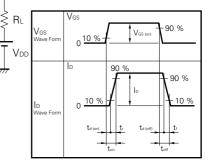
Test Circuit 1 Avalanche Capability

$PG \longrightarrow 50 \Omega \longrightarrow 77$ $V_{GS} = 20 - 0 \bigvee 77$ $W_{T} \longrightarrow 77$ $W_{T} \longrightarrow 77$ W_{DD}

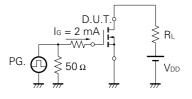


Test Circuit 2 Switching Time

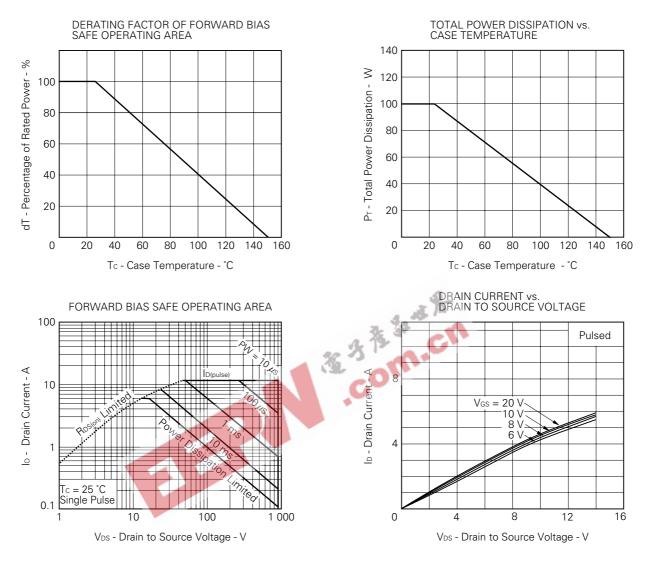




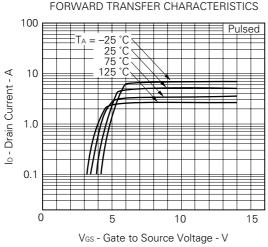
Test Circuit 3 Gate Charge



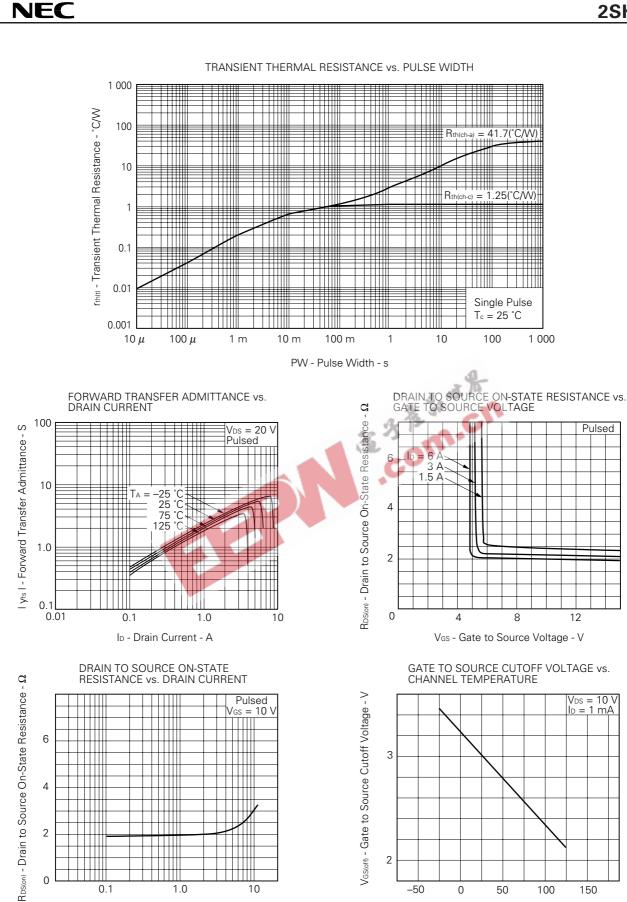
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.



TYPICAL CHARACTERISTICS ($T_A = 25$ °C)



FORWARD TRANSFER CHARACTERISTICS



ID - Drain Current - A

1.0

10

1 000

Pulsed

Single Pulse

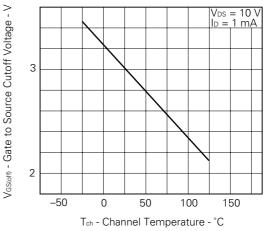
Tc = 25 °C

100

GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

8

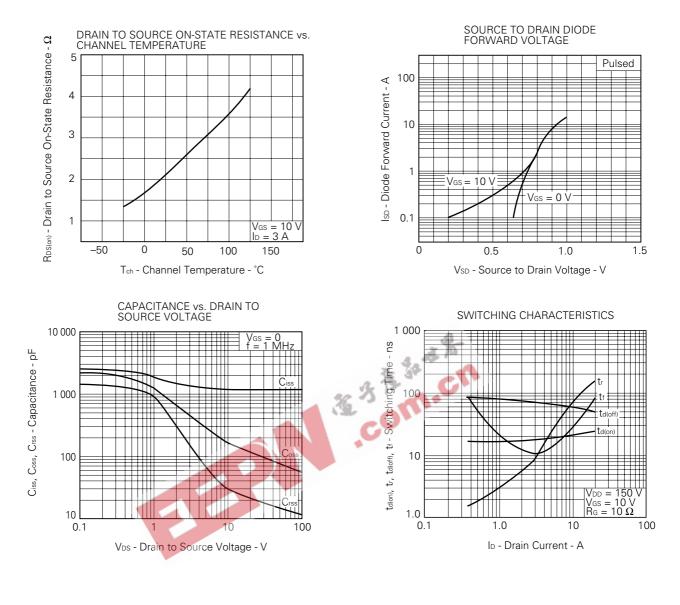
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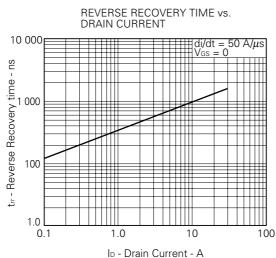
2

0

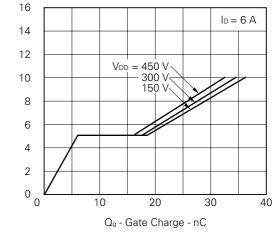
0.1



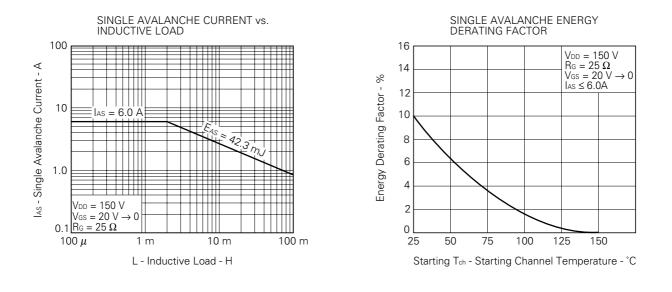
V_{GS} - Gate to Source Voltage - V



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5





REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037



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Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

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Anti-radioactive design is not implemented in this product.

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